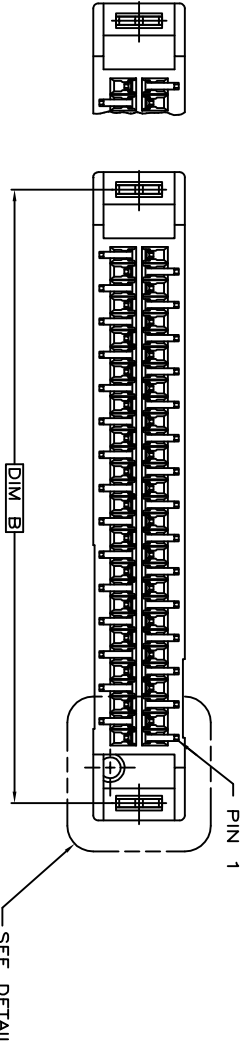
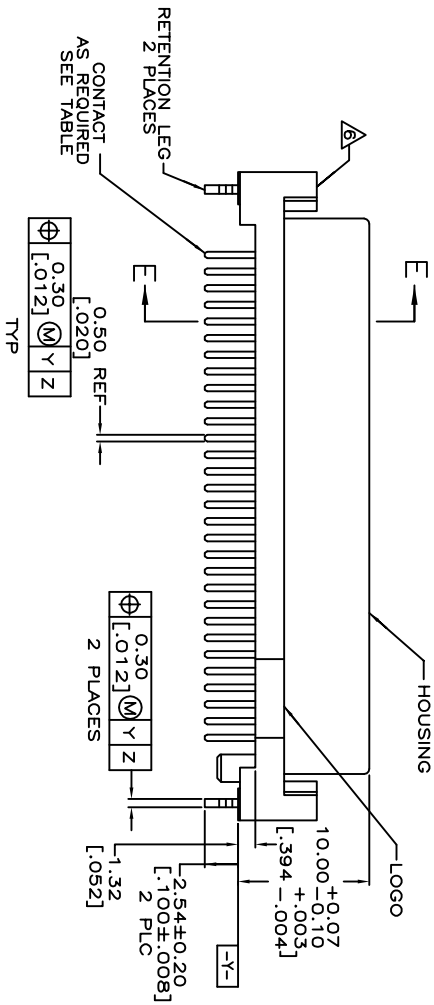
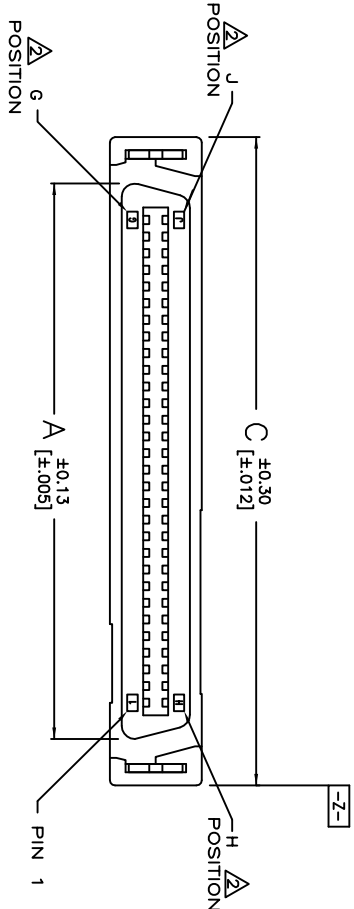
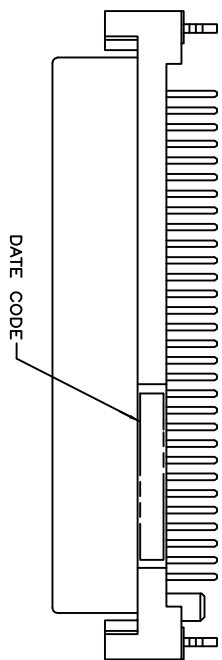


P	LTR	DESCRIPTION	DATE	DWN	APVD
E2		REVISED. ECR-15-016136	06NOV2015	J.W	S.H



MATERIALS:

HOUSING- PPA RESIN, BLACK, MOLDING COMPOUND.
PHOSPHOR BRONZE PLATED WITH MINIMUM THICK (SEE TABLE) GOLD IN CONTACT AREA AND 3.8 μ m [.000150] MINIMUM THICK MATTE TIN ON SOLDER TINES OVER 1.27 μ m MINIMUM THICK NICKEL UNDERPLATE.
RETENTION LEG- BRASS PLATED WITH 3.8 μ m [.000150] MINIMUM TIN-CU OVER 1.3 μ m [.000051] MINIMUM NICKEL UNDERPLATE.

- G, J, AND H INDICATE NUMBER OF POSITION MARKED ON ASSEMBLY. ALSO SEE TABLE.
- ALL DIMENSIONS SHOWN ARE MAXIMUM UNLESS OTHERWISE SPECIFIED.
- 60 POSITION AS SHOWN.
- RETENTION LEGS NOT PRESENT.
- TOP OF RETENTION LEG MAY NOT PROTRUDE ABOVE THIS SURFACE.
- HOUSING BOW UP TO 0.30 [.012] ALLOWED.
- CONNECTOR WILL ACCOMMODATE MATING PRINTED CIRCUIT BOARD OF 1.6 $\pm$ 0.07 [.063 $\pm$.003] THICKNESS.
- WAVE SOLDER CAPABLE TO 265 C PER TE SPEC 109-202, CONDITION B.
- REMOVE CONTACT POSITION FROM #11~#17 AND #36~#42.
- RECOMMEND CARD EDGE DIM. (PAGE2)
- GOLD FLASH OVER 0.762 μ m [30 μ] MIN. PALLADIUM-NICKEL PLATED.
- OBsolete
- REMOVE CONTACT POSITION FROM #23~#29 AND #57~#63.

2.36 [.093]	3.30 [.130]	127.43 [5.017]	138.35 [5.447]	135.71 [5.343]	131.27 [5.168]	GOLD FLASH 0.381um[15u]	5-1734101-6	
0.8-1.6 [.031-.063]	2.54 [.100]	102.03 [4.017]	112.95 [4.447]	110.31 [4.343]	105.87 [4.168]	0.381um[15u]	3-1734101-4	160
2.36 [.093]	3.30 [.130]	76.63 [3.017]	87.55 [3.447]	84.91 [3.343]	80.47 [3.168]	GOLD FLASH 0.381um[15u]	5-1734101-3	120
0.8-1.6 [.031-.063]	2.54 [.100]	76.63 [3.017]	87.55 [3.447]	84.91 [3.343]	80.47 [3.168]	0.381um[15u]	5-1734101-2	
2.36 [.093]	3.30 [.130]	63.93 [2.517]	74.85 [2.947]	72.21 [2.843]	67.77 [2.668]	GOLD FLASH 0.381um[15u]	5-1734101-1	100
0.8-1.6 [.031-.063]	2.54 [.100]	63.93 [2.517]	74.85 [2.947]	72.21 [2.843]	67.77 [2.668]	0.381um[15u]	5-1734101-0	
2.36 [.093]	3.30 [.130]	51.23 [2.017]	62.15 [2.447]	59.51 [2.343]	55.07 [2.168]	GOLD FLASH 0.381um[15u]	6-1734101-9	80
0.8-1.6 [.031-.063]	2.54 [.100]	51.23 [2.017]	62.15 [2.447]	59.51 [2.343]	55.07 [2.168]	0.381um[15u]	6-1734101-8	
2.36 [.093]	3.30 [.130]	43.61 [1.717]	54.53 [2.147]	51.89 [2.043]	47.45 [1.868]	GOLD FLASH 0.381um[15u]	7-1734101-7	68
0.8-1.6 [.031-.063]	2.54 [.100]	43.61 [1.717]	54.53 [2.147]	51.89 [2.043]	47.45 [1.868]	0.381um[15u]	7-1734101-6	
2.36 [.093]	3.30 [.130]	39.53 [1.517]	49.45 [1.947]	46.81 [1.843]	42.37 [1.668]	GOLD FLASH 0.381um[15u]	4-1734101-6	60
0.8-1.6 [.031-.063]	2.54 [.100]	39.53 [1.517]	49.45 [1.947]	46.81 [1.843]	42.37 [1.668]	0.381um[15u]	4-1734101-5	
2.36 [.093]	3.30 [.130]	32.18 [1.267]	43.10 [1.687]	40.46 [1.593]	36.02 [1.418]	GOLD FLASH 0.381um[15u]	5-1734101-7	50
0.8-1.6 [.031-.063]	2.54 [.100]	32.18 [1.267]	43.10 [1.687]	40.46 [1.593]	36.02 [1.418]	0.381um[15u]	5-1734101-6	
2.36 [.093]	3.30 [.130]	28.83 [1.107]	36.75 [1.447]	34.11 [1.343]	29.67 [1.168]	GOLD FLASH 0.381um[15u]	4-1734101-4	40
0.8-1.6 [.031-.063]	2.54 [.100]	28.83 [1.107]	36.75 [1.447]	34.11 [1.343]	29.67 [1.168]	0.381um[15u]	4-1734101-3	
2.36 [.093]	3.30 [.130]	30.40 [1.197]	27.96 [1.101]	23.32 [.918]	15	GOLD FLASH 0.381um[15u]	6-1734101-3	30
0.8-1.6 [.031-.063]	2.54 [.100]	30.40 [1.197]	27.96 [1.101]	23.32 [.918]	15	0.381um[15u]	6-1734101-3	

THIS DRAWING IS A CONTROLLED DOCUMENT.

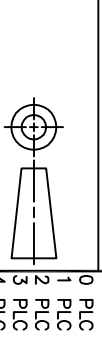
DWN 31MAR2009
F. YANG
CHK 31MAR2009
S. CHIEN
W. KODAMA
APVD 31MAR2009

TE Connectivity

DIMENSIONS: MM

TOLERANCES UNLESS OTHERWISE SPECIFIED:

RECEPTACLE ASSEMBLY,
VERTICAL, BOARD-TO-BOARD,
CHAMP.050, SERIES I,



QUALIFICATION TEST REPORT
108-57876

RESTRICTED 30

SEE NOTE

CUSTOMER DRAWING

SIZE CAGE CODE DRAWING NO
A3 00779 C=1734101

SCALE SHEET 1 OF 4 REV E2

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